

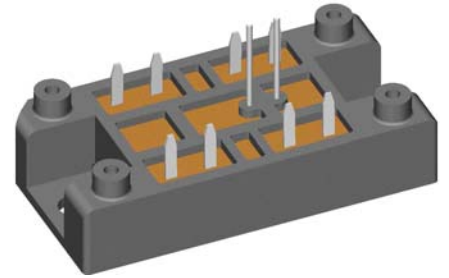
Standard Rectifier Module

3~ Rectifier	Brake Chopper
$V_{RRM} = 1600\text{ V}$	$V_{CES} = 1200\text{ V}$
$I_{DAV} = 75\text{ A}$	$I_{C25} = 58\text{ A}$
$I_{FSM} = 600\text{ A}$	$V_{CE(sat)} = 1.85\text{ V}$

3~ Rectifier Bridge + Brake Unit

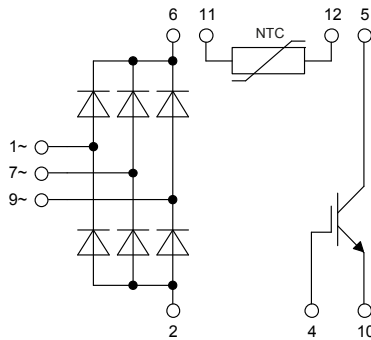
Part number

VUI72-16NOXT



Backside: isolated

E72873



Features / Advantages:

- Soldering connections for PCB mounting
- Convenient package outline
- NTC

Applications:

- 3~ Rectifier with brake unit for drive inverters

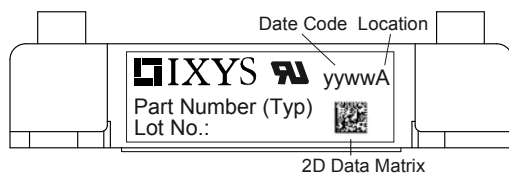
Package: V1-A-Pack

- Isolation Voltage: 3600V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Height: 17 mm
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

Rectifier				Ratings		
Symbol	Definition	Conditions	min.	typ.	max.	Unit
V_{RSM}	max. non-repetitive reverse blocking voltage	$T_{VJ} = 25^{\circ}C$			1700	V
V_{RRM}	max. repetitive reverse blocking voltage	$T_{VJ} = 25^{\circ}C$			1600	V
I_R	reverse current	$V_R = 1600 V$	$T_{VJ} = 25^{\circ}C$		40	μA
		$V_R = 1600 V$	$T_{VJ} = 150^{\circ}C$		1.5	mA
V_F	forward voltage drop	$I_F = 25 A$	$T_{VJ} = 25^{\circ}C$		1.10	V
		$I_F = 75 A$			1.38	V
		$I_F = 25 A$	$T_{VJ} = 125^{\circ}C$		1.01	V
		$I_F = 75 A$			1.37	V
I_{DAV}	bridge output current	$T_C = 110^{\circ}C$ rectangular $d = 1/3$	$T_{VJ} = 150^{\circ}C$		75	A
V_{FO}	threshold voltage	} for power loss calculation only	$T_{VJ} = 150^{\circ}C$		0.79	V
r_F	slope resistance				7.7	m Ω
R_{thJC}	thermal resistance junction to case				1.1	K/W
R_{thCH}	thermal resistance case to heatsink			0.3		K/W
P_{tot}	total power dissipation		$T_C = 25^{\circ}C$		110	W
I_{FSM}	max. forward surge current	$t = 10 ms; (50 Hz), sine$	$T_{VJ} = 45^{\circ}C$		600	A
		$t = 8,3 ms; (60 Hz), sine$	$V_R = 0 V$		650	A
		$t = 10 ms; (50 Hz), sine$	$T_{VJ} = 150^{\circ}C$		510	A
		$t = 8,3 ms; (60 Hz), sine$	$V_R = 0 V$		550	A
I^2t	value for fusing	$t = 10 ms; (50 Hz), sine$	$T_{VJ} = 45^{\circ}C$		1.80	kA ² s
		$t = 8,3 ms; (60 Hz), sine$	$V_R = 0 V$		1.76	kA ² s
		$t = 10 ms; (50 Hz), sine$	$T_{VJ} = 150^{\circ}C$		1.30	kA ² s
		$t = 8,3 ms; (60 Hz), sine$	$V_R = 0 V$		1.26	kA ² s
C_J	junction capacitance	$V_R = 400 V; f = 1 MHz$	$T_{VJ} = 25^{\circ}C$		19	pF

Brake IGBT				Ratings		
Symbol	Definition	Conditions	min.	typ.	max.	Unit
V_{CES}	collector emitter voltage	$T_{VJ} = 25^{\circ}\text{C}$			1200	V
V_{GES}	max. DC gate voltage				± 20	V
V_{GEM}	max. transient gate emitter voltage				± 30	V
I_{C25}	collector current	$T_C = 25^{\circ}\text{C}$			58	A
I_{C80}		$T_C = 80^{\circ}\text{C}$			40	A
P_{tot}	total power dissipation	$T_C = 25^{\circ}\text{C}$			195	W
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 35\text{ A}; V_{GE} = 15\text{ V}$			1.85	V
					2.15	V
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 1.5\text{ mA}; V_{GE} = V_{CE}$	5.4	5.9	6.5	V
I_{CES}	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0\text{ V}$			0.1	mA
					0.1	mA
I_{GES}	gate emitter leakage current	$V_{GE} = \pm 20\text{ V}$			500	nA
$Q_{G(on)}$	total gate charge	$V_{CE} = 600\text{ V}; V_{GE} = 15\text{ V}; I_C = 35\text{ A}$		110		nC
$t_{d(on)}$	turn-on delay time	inductive load $V_{CE} = 600\text{ V}; I_C = 35\text{ A}$ $V_{GE} = \pm 15\text{ V}; R_G = 27\ \Omega$		70		ns
t_r	current rise time		$T_{VJ} = 125^{\circ}\text{C}$	40		ns
$t_{d(off)}$	turn-off delay time		250		ns	
t_f	current fall time		100		ns	
E_{on}	turn-on energy per pulse		3.8		mJ	
E_{off}	turn-off energy per pulse		4.1		mJ	
RBSOA	reverse bias safe operating area	$V_{GE} = \pm 15\text{ V}; R_G = 27\ \Omega$				
I_{CM}		$V_{CEK} = 1200\text{ V}$			105	A
SCSOA	short circuit safe operating area					
t_{sc}	short circuit duration	$V_{CE} = 900\text{ V}; V_{GE} = \pm 15\text{ V}$			10	μs
I_{sc}	short circuit current	$R_G = 27\ \Omega$; non-repetitive		140		A
R_{thJC}	thermal resistance junction to case				0.65	K/W
R_{thCH}	thermal resistance case to heatsink			0.25		K/W

Package V1-A-Pack				Ratings		
Symbol	Definition	Conditions	min.	typ.	max.	Unit
I_{RMS}	RMS current	per terminal			100	A
T_{stg}	storage temperature		-40		125	°C
T_{VJ}	virtual junction temperature		-40		150	°C
Weight				37		g
M_D	mounting torque		2		2.5	Nm
$d_{Spp/App}$	creepage distance on surface striking distance through air	terminal to terminal	6.0			mm
$d_{Spb/Apb}$		terminal to backside	12.0			mm
V_{ISOL}	isolation voltage	t = 1 second	3600			V
		t = 1 minute 50/60 Hz, RMS; $I_{ISOL} \leq 1$ mA	3000			V



Ordering	Part Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	VUI72-16NOXT	VUI72-16NOXT	Box	10	510748

Temperature Sensor NTC

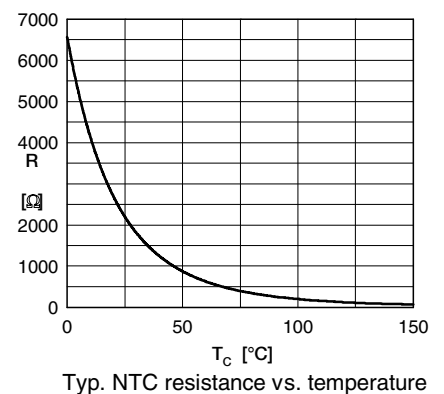
Symbol	Definition	Conditions	min.	typ.	max.	Unit
R_{25}	resistance	$T_{VJ} = 25^\circ$	2.13	2.2	2.27	k Ω
$B_{25/50}$	temperature coefficient			3560		K

Equivalent Circuits for Simulation

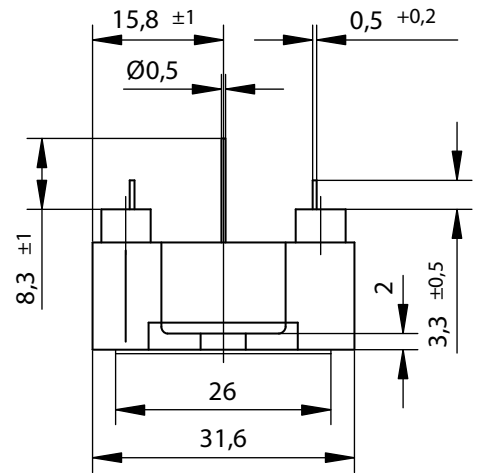
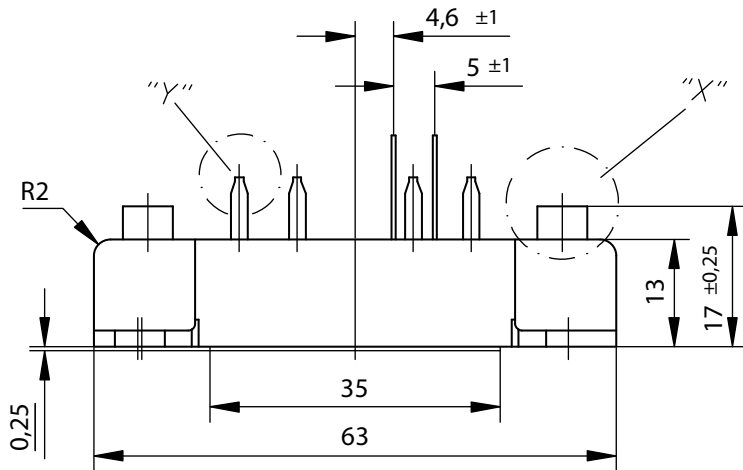
* on die level

$T_{VJ} = 150^\circ\text{C}$

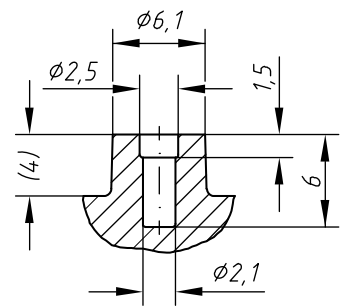
		Rectifier	Brake IGBT	
V_0	threshold voltage	0.79	1.1	V
R_0	slope resistance *	6.5	40	m Ω



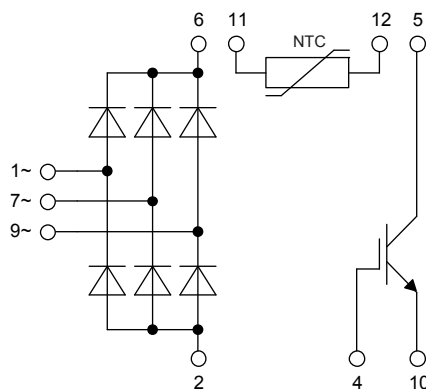
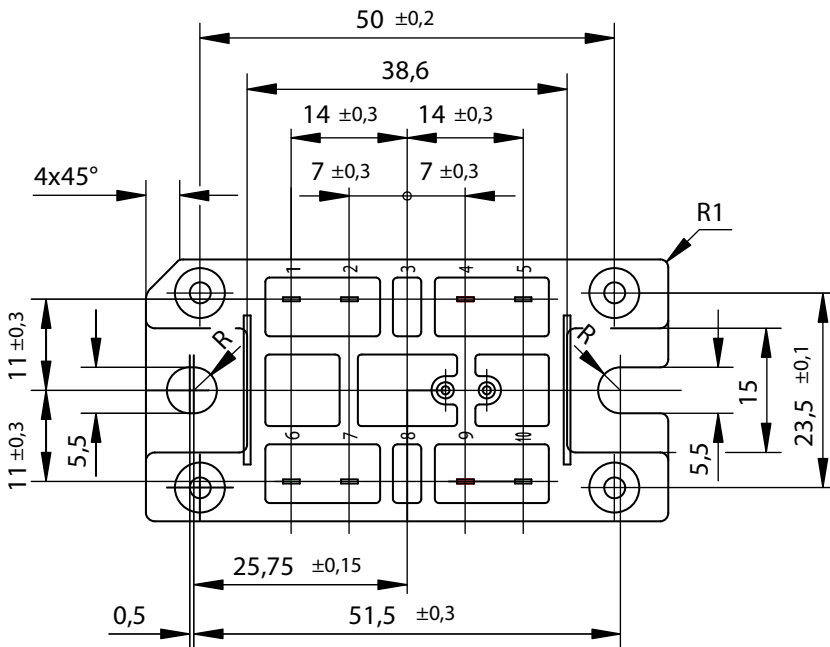
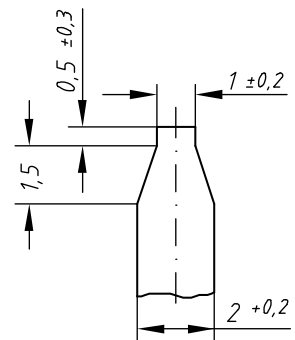
Outlines V1-A-Pack



Detail "X" M 2:1



Detail "Y" M 5:1



Rectifier

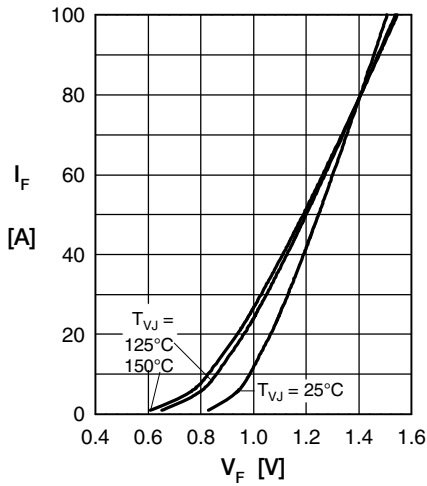


Fig. 1 Forward current vs. voltage drop per diode

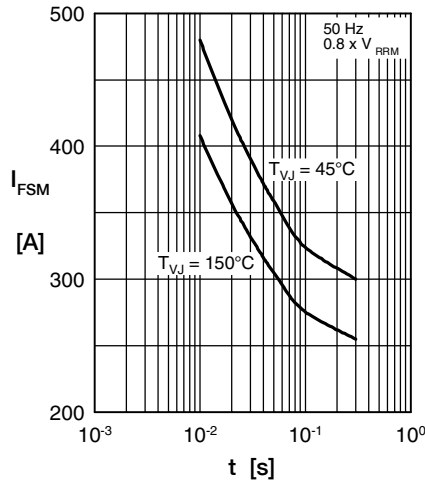


Fig. 2 Surge overload current vs. time per diode

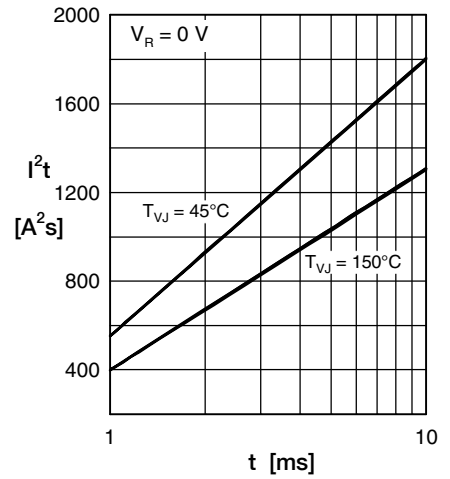


Fig. 3 I^2t vs. time per diode

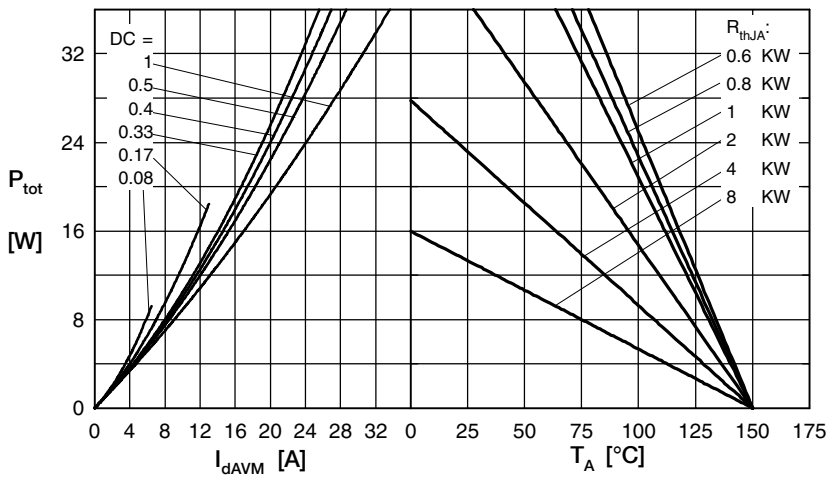


Fig. 4 Power dissipation vs. forward current and ambient temperature per diode

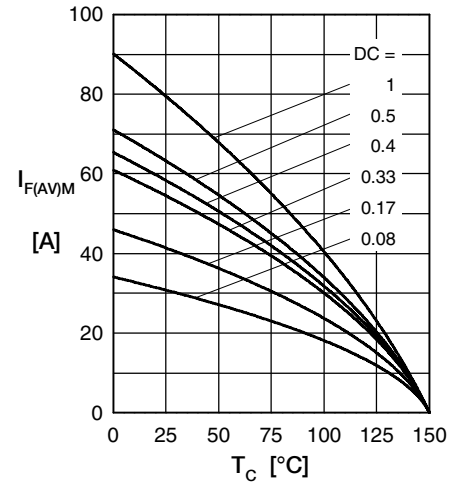


Fig. 5 Max. forward current vs. case temperature per diode

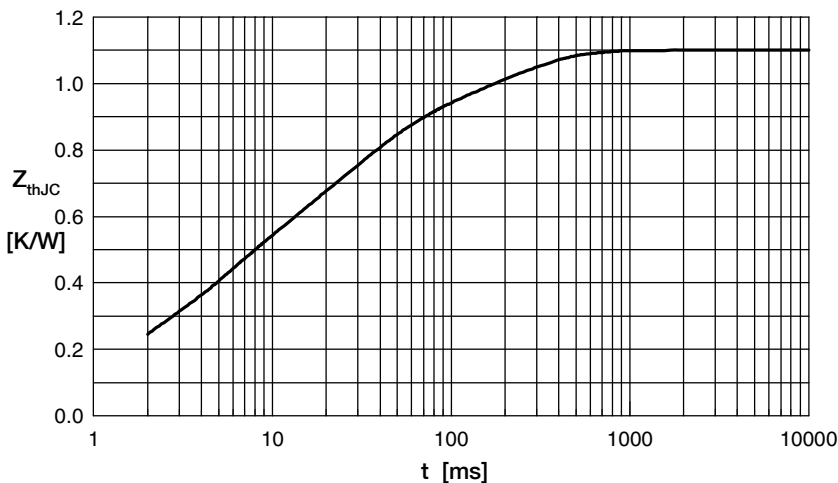


Fig. 6 Transient thermal impedance junction to case vs. time per diode

Constants for Z_{thJC} calculation:

i	R_{th} (K/W)	t_i (s)
1	0.0607	0.0004
2	0.1230	0.00256
3	0.2305	0.0045
4	0.4230	0.0242
5	0.2628	0.1800

Brake IGBT

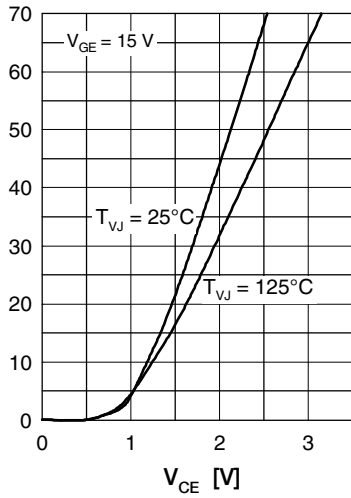


Fig. 1 Typ. output characteristics

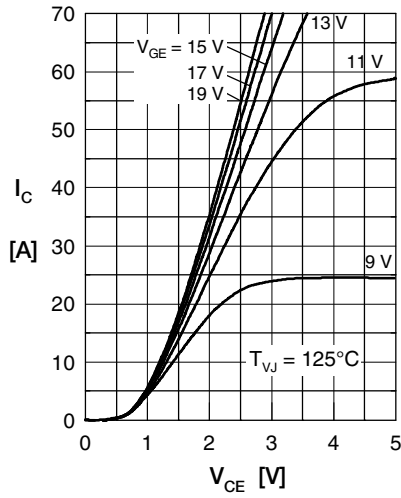


Fig. 2 Typ. output characteristics

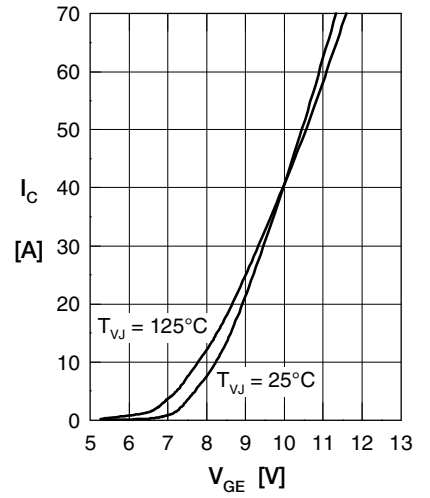


Fig. 3 Typ. transfer characteristics

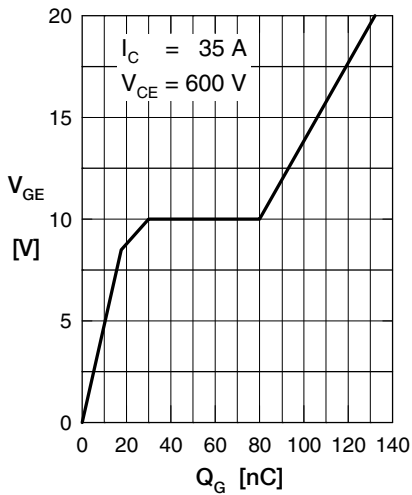


Fig. 4 Typ. turn-on gate charge

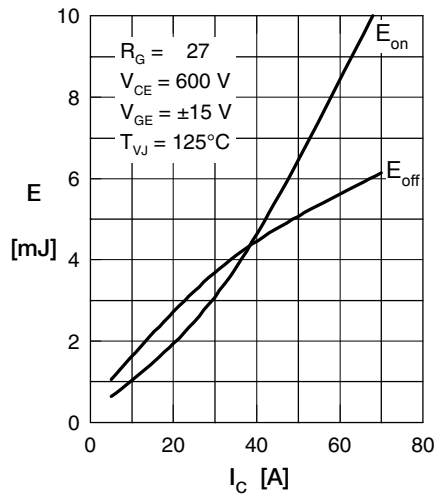


Fig. 5 Typ. switching energy versus collector current

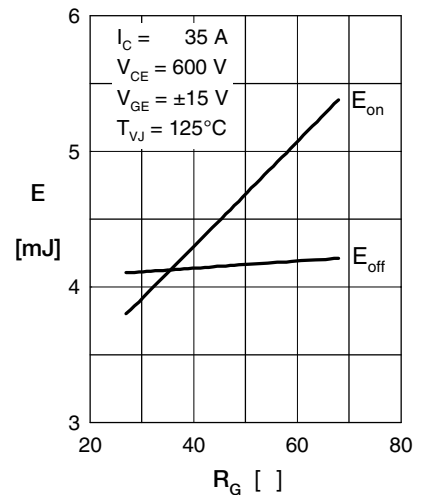


Fig. 6 Typ. switching energy versus gate resistance

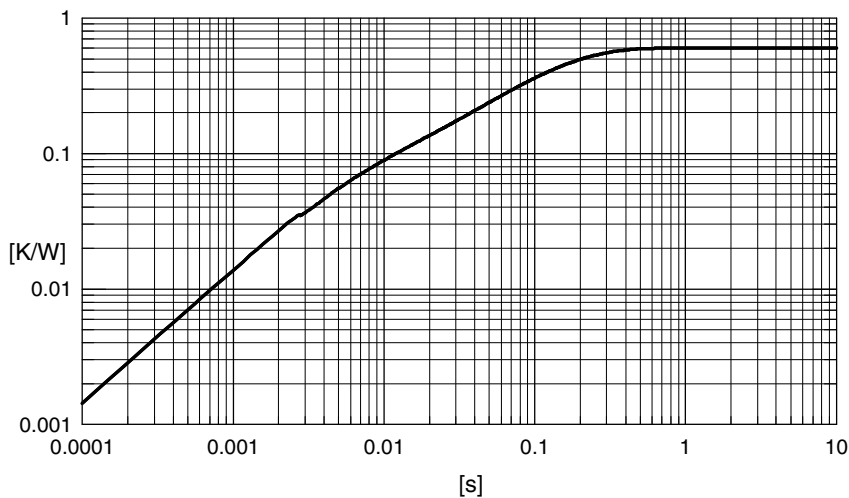


Fig. 7 Typ. transient thermal impedance